

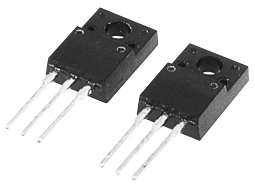
PRELIMINARY
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 Some parametric limits are subject to change.

MITSUBISHI Pch POWER MOSFET

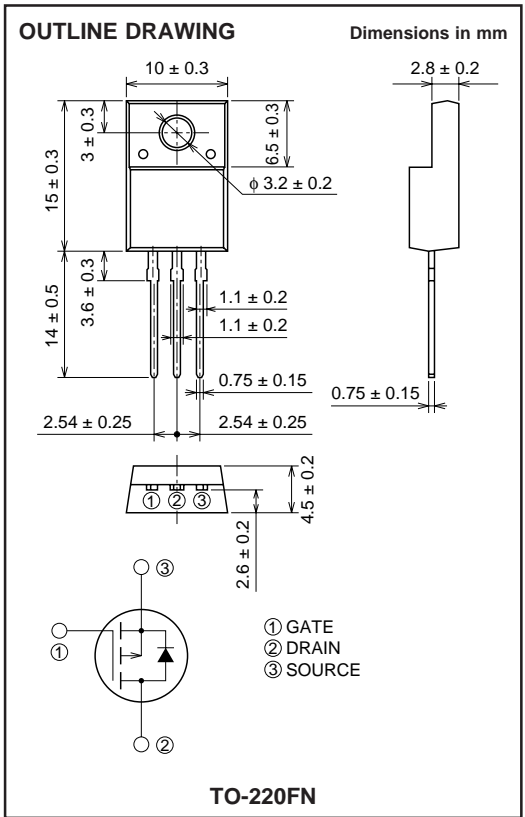
FX30KMJ-06

HIGH-SPEED SWITCHING USE

FX30KMJ-06



- 4V DRIVE
- V_{DSS} -60V
- $r_{DS(ON)}$ (MAX) $54m\Omega$
- I_D -30A
- Integrated Fast Recovery Diode (TYP.) 55ns
- V_{iso} 2000V



APPLICATION

Motor control, Lamp control, Solenoid control
 DC-DC converter, etc.

MAXIMUM RATINGS (Tc = 25°C)

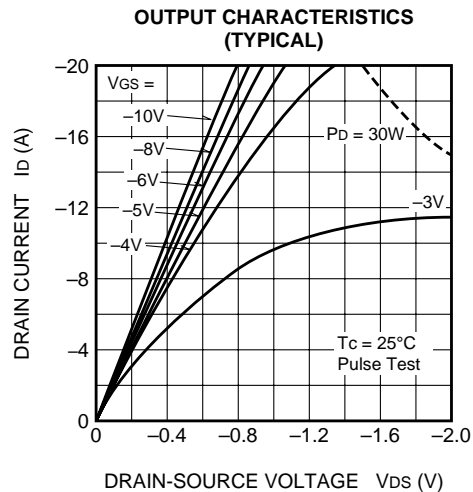
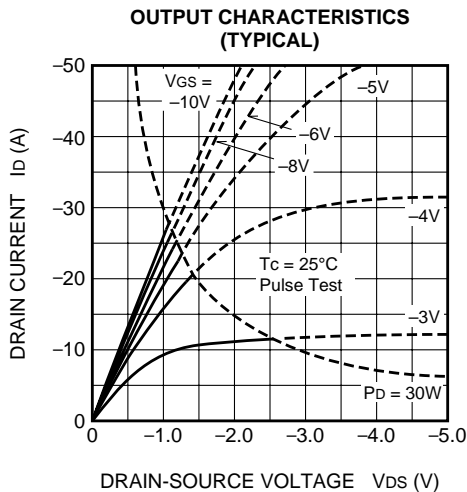
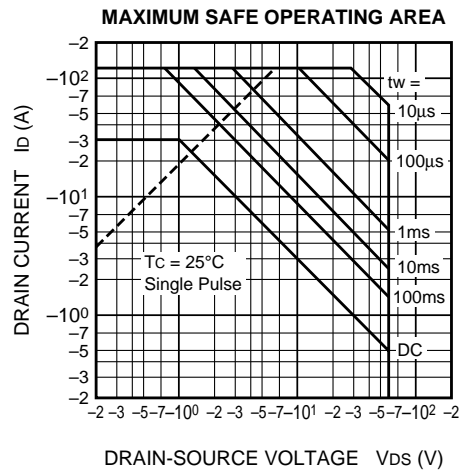
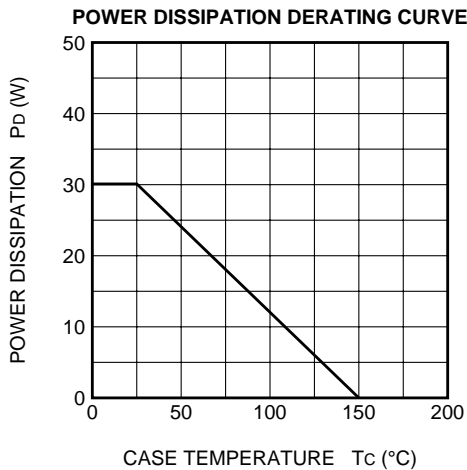
Symbol	Parameter	Conditions	Ratings	Unit
V_{DSS}	Drain-source voltage	$V_{GS} = 0V$	-60	V
V_{GSS}	Gate-source voltage	$V_{DS} = 0V$	± 20	V
I_D	Drain current		-30	A
I_{DM}	Drain current (Pulsed)		-120	A
I_{DA}	Avalanche drain current (Pulsed)	$L = 50\mu H$	-30	A
I_S	Source current		-30	A
I_{SM}	Source current (Pulsed)		-120	A
P_D	Maximum power dissipation		30	W
T_{ch}	Channel temperature		-55 ~ +150	°C
T_{stg}	Storage temperature		-55 ~ +150	°C
V_{iso}	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

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ELECTRICAL CHARACTERISTICS (Tch = 25°C)

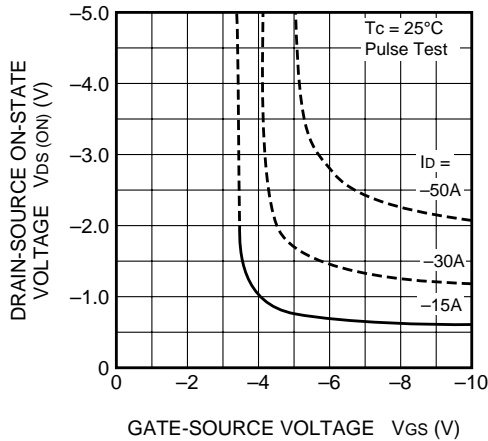
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V (BR) DSS	Drain-source breakdown voltage	ID = -1mA, VGS = 0V	-60	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = -60V, VGS = 0V	—	—	-0.1	mA
VGS (th)	Gate-source threshold voltage	ID = -1mA, VDS = -10V	-1.3	-1.8	-2.3	V
rDS (ON)	Drain-source on-state resistance	ID = -15A, VGS = -10V	—	41	54	mΩ
rDS (ON)	Drain-source on-state resistance	ID = -15A, VGS = -4V	—	66	92	mΩ
VDS (ON)	Drain-source on-state voltage	ID = -15A, VGS = -10V	—	-0.62	-0.81	V
yfs	Forward transfer admittance	ID = -15A, VDS = -10V	—	22	—	S
Ciss	Input capacitance	VDS = -10V, VGS = 0V, f = 1MHz	—	4210	—	pF
Coss	Output capacitance		—	466	—	pF
Crss	Reverse transfer capacitance		—	265	—	pF
td (on)	Turn-on delay time		—	18	—	ns
tr	Rise time	VDD = -30V, ID = -15A, VGS = -10V, RGEN = RGS = 50Ω	—	56	—	ns
td (off)	Turn-off delay time		—	274	—	ns
tf	Fall time		—	131	—	ns
VSD	Source-drain voltage		IS = -15A, VGS = 0V	—	-1.0	-1.5
Rth (ch-c)	Thermal resistance	Channel to case	—	—	4.17	°C/W
trr	Reverse recovery time	IS = -30A, dis/dt = 100A/μs	—	55	—	ns

PERFORMANCE CURVES

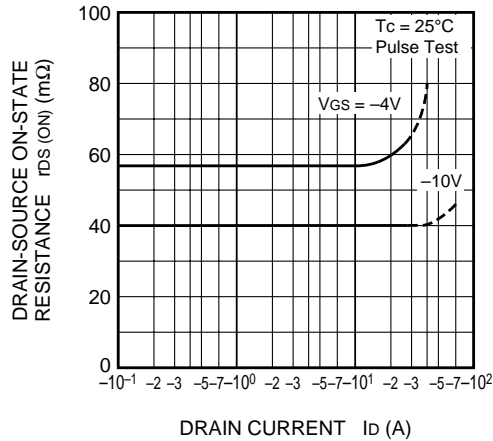


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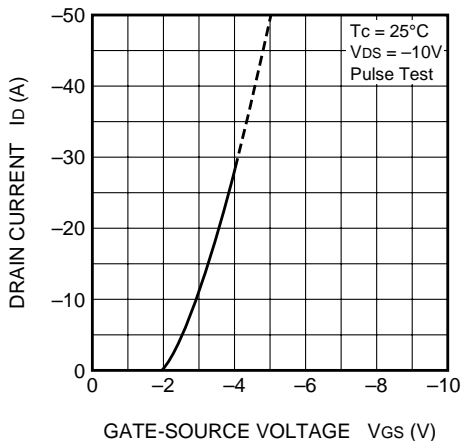
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



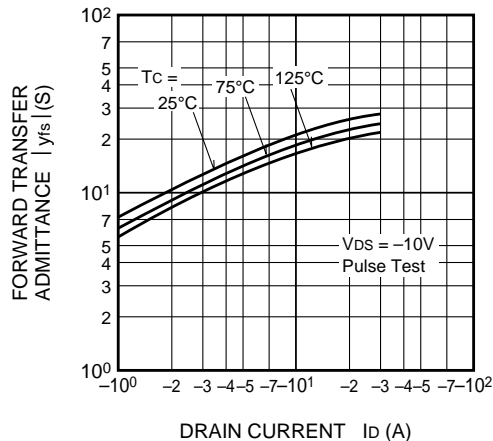
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



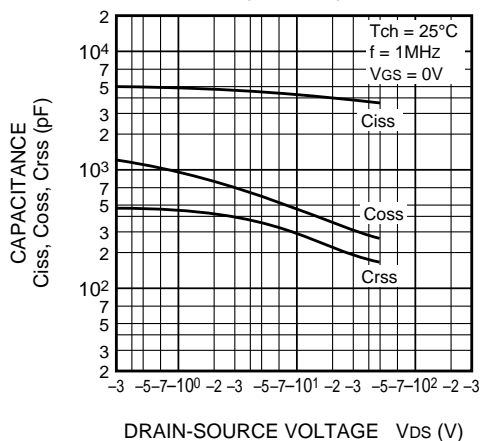
TRANSFER CHARACTERISTICS (TYPICAL)



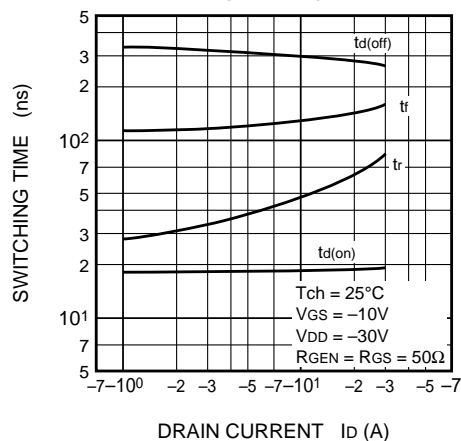
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)

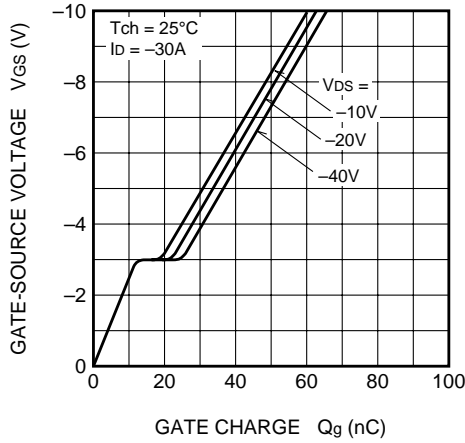


SWITCHING CHARACTERISTICS (TYPICAL)

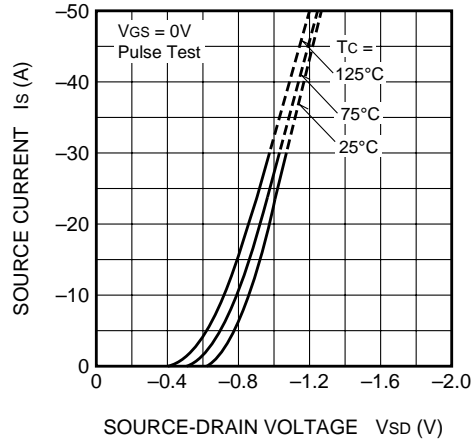


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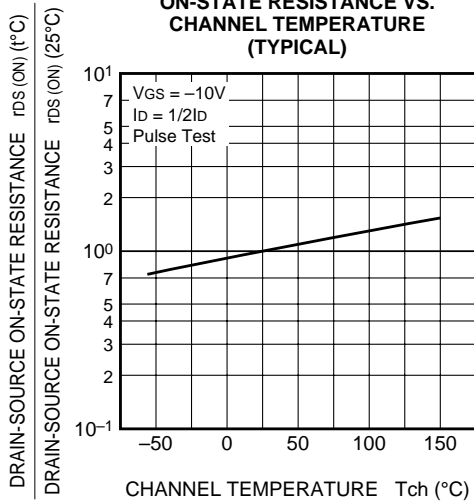
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



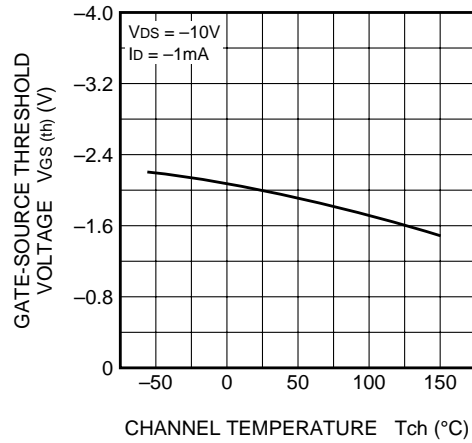
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



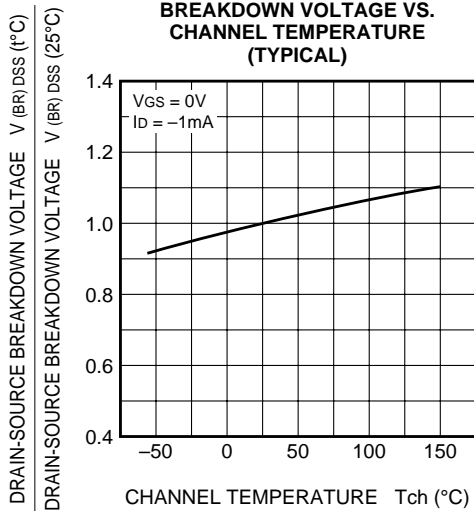
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

